400mA SmartOR[™] Dual Regulator with V_{AUX} Switch

Features

- Continuous 3.3V output from three inputs
- · Complete power management solution
- V_{CC}, V_{SBY} regulator supplies 400mA output
- Built-in hysteresis when selecting input supplies
- Integrated switch has very low $R_{DS(ON)}$ 0.25 Ω (TYP)
- Foldback current limiting protection
- Thermal overload shutdown protection
- 8-pin power SOIC package

Applications

- PCI adapter cards with Wake-On-LAN
- Network Interface Cards (NICs)
- Multiple power systems
- · Systems with standby capabilities

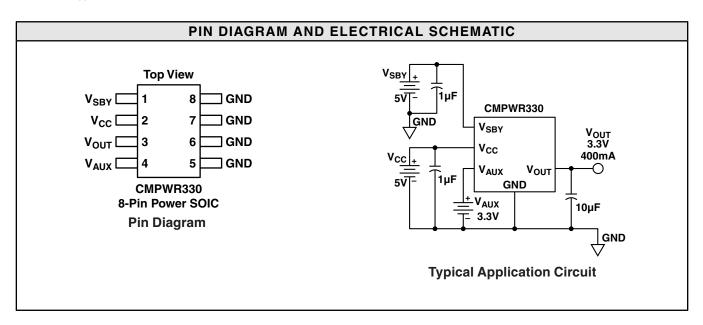
Product Description

The CMPWR330 is a dual input regulator with a fully integrated V_{AUX} switch capable of delivering up to 400mA continuously at 3.3V. The output power is provided from three independent input voltage sources on a prioritized basis. Power is always taken in priority using the following order V_{CC}, V_{SBY}, and V_{AUX}.

When $\rm V_{\rm CC}$ (5V) or $\rm V_{\rm SBY}$ is present, the device automatically enables the regulator and produces a stable 3.3V output at $\rm V_{out}.$

When only V_{_{AUX}} (3.3V) is present, the device provides a low impedance direct connection (0.25 Ω TYP) from V_{_{AUX}} to V_ $_{_{OUT}}$.

All the necessary control circuitry needed to provide a smooth and automatic transition between all three supplies has been incorporated. This allows the $V_{\rm cc}$ input supply to be dynamically switched without loss of output voltage.



STANDARD PART ORDERING INFORMATION				
Package		Ordering Part Number		
Pins	Style Tubes Tape & Reel Part Markir		Part Marking	
8	Power SOIC	CMPWR330SA/T	CMPWR330SA/R	CMPWR330SA

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ABSOLUTE MAXIMUM RATINGS				
Parameter	Rating	Unit		
ESD Protection (HBM)	2000	V		
V _{CC} , V _{SBY} Input Voltage	6.0, GND –0.5	V		
V _{AUX} Input Voltage	4.0, GND -0.5	V		
Temperature: Storage	-40 to 150	°C		
Operating Ambient	0 to 70	°C		
Operating Junction	0 to 125	°C		
Power Dissipation: (Note 1)	Internally Limited	W		

OPERATING CONDITIONS			
Parameter	Range	Unit	
V _{CC} , V _{SBY}	5 ± 0.25	V	
V _{AUX}	3.3 ± 0.3	V	
Temperature (Ambient)	0 to 70	°C	
Load Current	0 to 400	mA	
C _{EXT}	10 ± 20%	μF	

ELECTRICAL OPERATING CHARACTERISTICS (over operating conditions unless specified otherwise)						
Symbol	Parameter	Conditions	MIN	ТҮР	MAX	UNIT
V _{OUT}	Regulator Output Voltage	$0mA < I_{LOAD} < 400mA$	3.135	3.30	3.465	V
I _{LIM}	Regulator Current Limit			500		mA
I _{S/C}	Short Circuit Current	$V_{CC/SBY} = 5V, V_{out} = 0V$		150		mA
V _{R LOAD}	Load Regulation	$V_{CC} = 5V$, $I_{LOAD} = 5$ to 400mA		20		mV
V _{R LINE}	Line Regulation	$V_{CC} = 4.5V$ to 5.5V, $I_{LOAD} = 5mA$		2		mV
V _{CCSEL}	V _{CC} Select Voltage	V _{SBY} or V _{AUX} present		4.40	4.60	V
V _{CCDES}	V _{CC} Deselect Voltage	V _{SBY} or V _{AUX} present	4.00	4.20		V
V _{HYST}	Hysteresis Voltage (Note 2)	V _{SBY} or V _{AUX} present		0.20		V
R _{SW}	V _{AUX} Switch Resistance			0.25	0.4	Ω
I _{RCC}	V _{CC} Reverse Leakage	One supply input taken to				
I _{RSBY}	V _{SBY} Reverse Leakage	ground while the others remain		5	100	μΑ
I _{RAUX}	V _{AUX} Reverse Leakage	at nominal voltage				
I _{CC}	V _{CC} Supply Current	$V_{CC} > V_{CCSEL}$, $I_{LOAD} = 0mA$		0.8	1.5	mA
I _{SBY}	V _{SBY} Supply Current	$V_{CC} < V_{CCDES}, I_{LOAD} = 0mA$		0.8	1.5	mA
I _{AUX}	V _{AUX} Supply Current	V_{AUX} is selected, $I_{LOAD} = 0mA$		0.2	0.30	mA
I _{GND}	Ground Current	V_{AUX} is selected, ($v_{CC/SBY} = 0V$)		0.2	0.30	mA
		$V_{CC/SBY} = 5V, I_{LOAD} = 0mA$		0.8	1.5	mA
		$V_{CC/SBY} = 5V$, $I_{LOAD} = 400$ mA		1.0	2.0	mA
T _{DISABLE}	Shutdown Temperature			160		°C
T _{HYST}	Thermal Hysteresis			20		°C

Note 1: At rated load, the power dissipation will be 0.68W (1.7V x 0.4A). Under these conditions, (in a 70°C ambient), the thermal resistance from junction to ambient (θ_{JA}) must not exceed 80°C/W. This is typically achieved with 2 square inches of copper printed circuit board area connected to the GND pins for heat spreading, or equivalent.

Note 2: The disturbance on V_{CC} during supply changeover should be kept below the hysteresis voltage to prevent any chatter. The source resistance on the V_{CC} supply should be kept to less than 0.3Ω to ensure precise switching.

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Interface Signals

 \mathbf{V}_{cc} is a positive input supply for the voltage regulator. Whenever this supply voltage exceeds the V_{cCSEL} level (4.4V), it will immediately be given priority and be used to power the regulator output. If this supply voltage falls below the V_{cCDES} level (4.2V) it will immediately be deselected and no longer provide power for the regulator output. An internal hysteresis voltage of 0.2V is used to prevent any chatter during selection and deselection of V_{cc} . The effective source impedance of V_{cc} should be kept below 0.3 Ω to ensure changeover disturbances do not exceed the hysteresis level.

If the connection to V_{cc} is made within a few inches of the main input filter, a bypass capacitor may not be necessary. Otherwise a bypass filter capacitor in the range of 1µF to 10µF will ensure adequate filtering.

 $V_{\rm SBY}$ is the standby input supply (5V), which is immediately used to power the regulator output whenever V_{cc} is below the deselect level (4.2V).

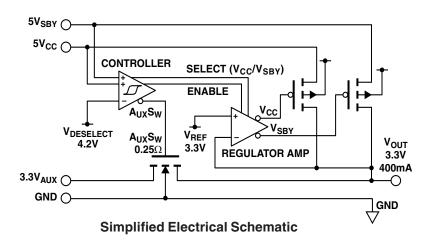
If the V_{SBY} connection is made within a few inches of the main input filter, a bypass capacitor may not be necessary. Otherwise a bypass filter capacitor in the range of 1µF to 10µF will ensure adequate filtering.

 \mathbf{V}_{AUX} is the auxiliary voltage power source. This supply is selected only when V_{CC} falls below 4.2V and the V_{SBY} is not present. Under these conditions an internal switch is enabled and provides a very low impedance connection directly between V_{OUT} and V_{AUX} .

 V_{out} is the output voltage. Power is provided from the regulator or via the low impedance auxiliary switch. This output requires a capacitance of 10μ F to ensure regulator stability and minimize the peak output disturbance during power supply changeover.

GND provides the reference for all voltages.

	INTERFACE SIGNALS			
Pin	Symbol	Description		
1	V _{SYB}	Standby supply voltage (5V) input for regulator whenever V_{CC} falls below 4.2V.		
2	V _{CC}	Primary supply voltage (5V) input for regulator		
3	V _{OUT}	Regulator voltage output (3.3V) regulator when either V_{CC} or V_{SYB} is present		
4	V _{AUX}	Auxiliary supply voltage (3.3V) input for low impedance switch		
5 - 8	GND	Reference for all voltages		



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Typical DC Characteristics (nominal conditions unless specified otherwise)

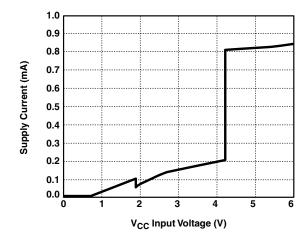


Figure 1. V_{cc} Supply Current vs Voltage

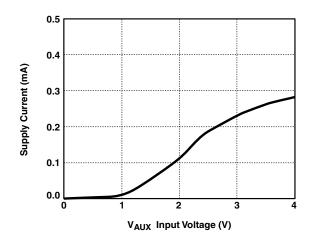


Figure 3. V_{AUX} Supply Current vs Voltage

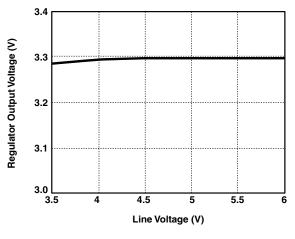


Figure 5. Line Regulation (5mA Load)



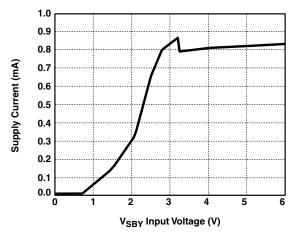


Figure 2. V_{SBY} Supply Current vs Voltage

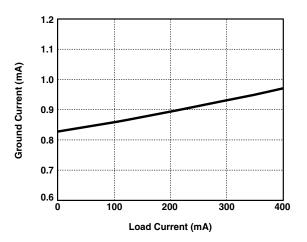


Figure 4. Ground Current vs Output Load

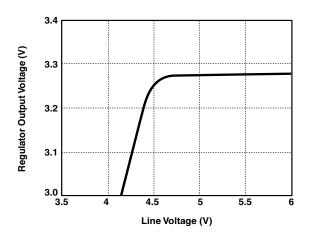


Figure 6. Line Regulation (400mA Load)

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Typical DC Characteristics

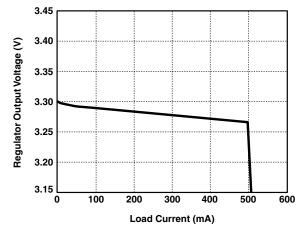


Figure 7. Load Regulation (5V Supply)

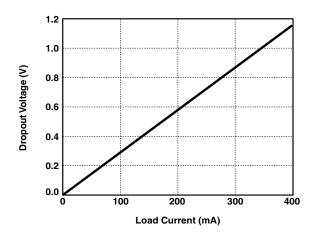


Figure 9. Regulator Dropout Characteristics

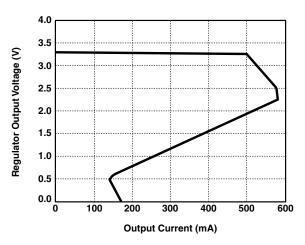


Figure 8. Foldback Current Limit Protection

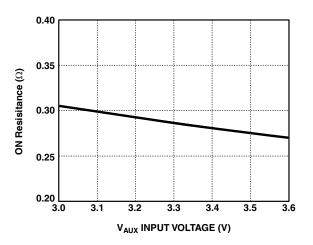
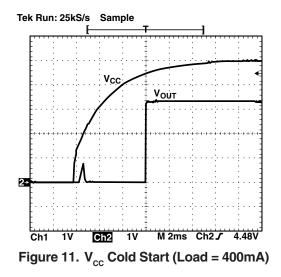


Figure 10. Switch Resistance vs V_{AUX} Supply

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Typical Transient Characteristics (Supply source resistance set to 0.2Ω)



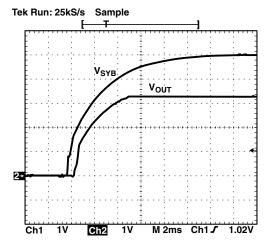
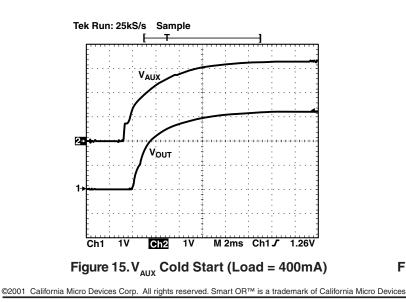


Figure 13. V_{SBY} Cold Start (Load = 400mA)



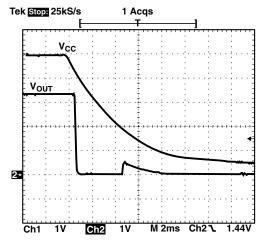


Figure 12. V_{cc} Full Power Down (Load = 400mA)

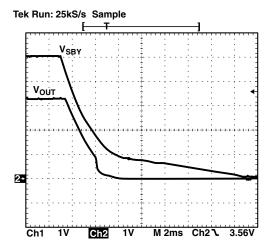
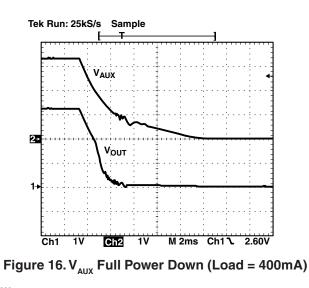


Figure 14. V_{SBY} Full Power Down (Load = 400mA)



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Typical Transient Characteristics (V_{CC} source resistance set to 0.2 Ω)

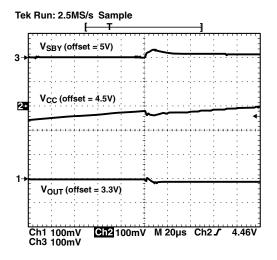


Figure 17. V_{cc} Power Up (V_{SBY} = 5V, Load = 300mA)

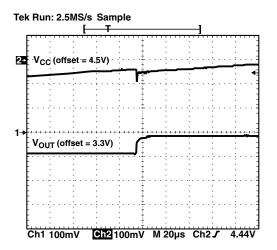
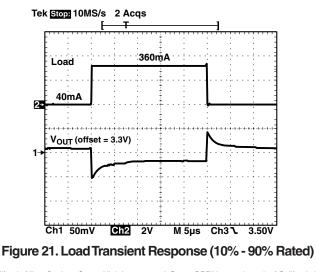
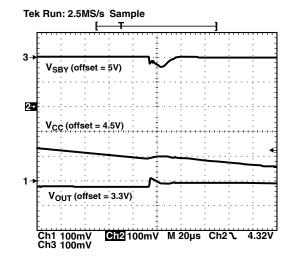
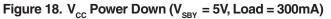


Figure 19. V_{cc} Power Up (V_{AUX} = 3.3V, Load = 300mA)







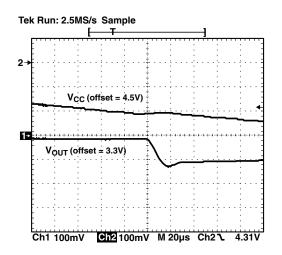
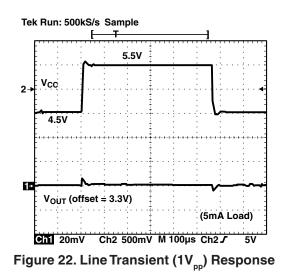


Figure 20. V_{cc} Power Down (V_{AUX} = 3.3V, Load = 300mA)



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Typical Thermal Characteristics

The overall junction to ambient thermal resistance (θ_{JA}) for device power dissipation (P_D) consists primarily of two paths in series. The first path is the junction to the case (θ_{JC}) which is defined by the package style, and the second path is case to ambient (θ_{CA}) thermal resistance which is dependent on board layout. The final operating junction temperature for any set of conditions can be estimated by the following thermal equation:

$$T_{JUNC} = T_{AMB} + P_{D} (\theta_{JC}) + P_{D} (\theta_{CA})$$
$$= T_{AMB} + P_{D} (\theta_{IA})$$

The CMPWR330 uses a thermally enhanced package where all the GND pins (5 through 8) are integral to the leadframe. When this package is mounted on a double sided printed circuit board with two square inches of copper allocated for "heat spreading", the resulting θ_{JA} is 50°C/W.

Based on a maximum power dissipation of 0.7W (1.75V x 0.4A) with an ambient of 70°C the resulting junction temperature will be:

$$T_{JUNC} = T_{AMB} + P_{D} (\theta_{JA})$$

= 70°C + 0.7W (50°C/W)
= 70°C + 35°C = 105°C

Thermal characteristics were measured using a double sided board with two square inches of copper area connected to the GND pins for "heat spreading".

Measurements showing performance up to junction temperature of 125°C were performed under light load conditions (5mA). This allows the ambient temperature to be representative of the internal junction temperature.

Note: The use of multi-layer board construction with separate ground and power planes will further enhance the overall thermal performance. In the event of no copper area being dedicated for heat spreading, a multi-layer board construction, using only the minimum size pad layout, will typically provide the CMPWR330 with an overall θ_{JA} of 70°C/W which allows up to 780mW to be safely dissipated.

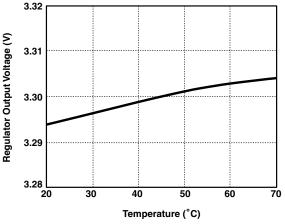
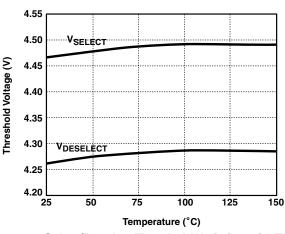
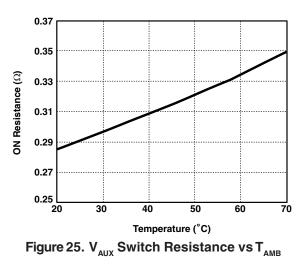


Figure 23. Vour Variation with T_{AMB} (400mA Load)_T







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